

## M24C64T-FCU Errata sheet

## M24C64T-FCU package mechanical data modifications

#### Silicon identification

This errata sheet applies to the M24C64T-FCU, that is the 64 Kbit serial I<sup>2</sup>C bus EEPROM delivered in WLCSP four balls.

The impacted part number is M24C64T-FCU6T/TF.

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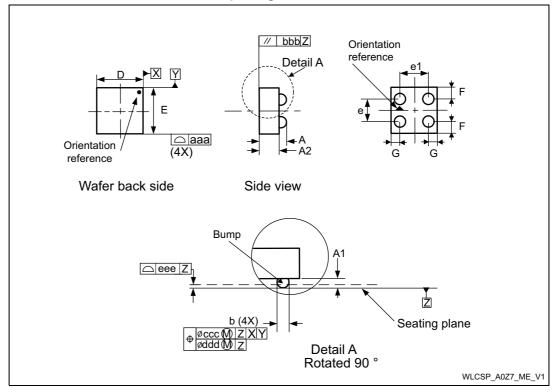


## 1 M24C64T-FCU physical product change

There isn't any physical product change.

Figure 1 shows the package outline.

Figure 1. Ultra Thin WLCSP- 4-bump, 0.851 x 0.851 mm, wafer level chip scale package outline



The figures below show the difference between D and E dimension in the front side view (see *Figure 2*), back side (see *Figure 3*) and side view (see *Figure 4*).

Figure 2. D and E front side view

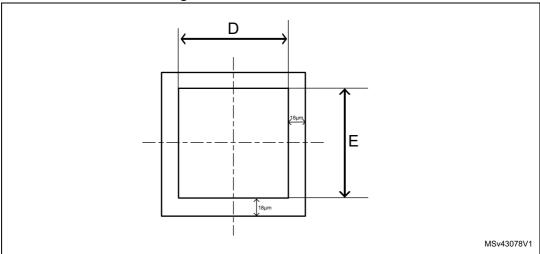
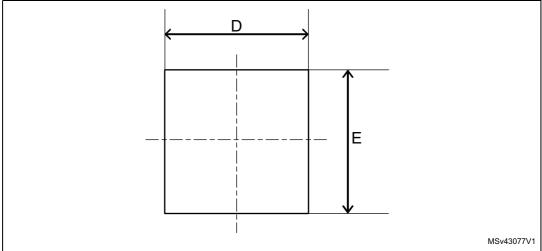


Figure 3. D and E back side view



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Figure 4. D or E side view

### 2 Package mechanical data modifications

This document refers to the changes of dimensions D and E (see *Figure 3*) described in the M24C64T-FCU datasheet, in tables detailing the dimensions of the Ultra Thin WLCSP 4-bump package.

D and E values must be modified to correct the following mistake:

The D and E values on M24C64T-FCU datasheet correspond to front side view (ball side), instead of back side view (marking side view).
Table 1 and Table 2 report the data for the front and back view, respectively.

Table 1. D and E values corresponding to front side view

Symbol		Millimeters			Inches		
Symbol	Min	Тур	Max	Min	Тур	Max	
D	-	0.833	0.853	-	0.0328	0.0336	
E	-	0.833	0.853	-	0.0328	0.0336	

Table 2. D and E values corresponding to back side view

Symbol			Millimeters		Inches	
Symbol	Min	Тур	Max	Min	Тур	Max
D	0.831	0.851	0.871	0.0327	0.0335	0.0343
E	0.831	0.851	0.871	0.0327	0.0335	0.0343

The difference between back side and front side dimension is 18  $\mu$ m (0.018 mm). This difference is due to two-step sawing process, where cut 1 and cut 2 are performed with blades having different thickness (see *Figure 4* in which X represents D or E and it has the same value and tolerance).

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M24C64T-FCU Revision history

# 3 Revision history

Table 3. Document revision history

	Date	Revision	Changes
i	08-Jul-2016	1	Initial release.

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